



Dual N-Channel 40 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^a	Q _g (Typ.)		
40	0.020 at V _{GS} = 10 V	9.2	4.9		
40	0.023 at V _{GS} = 4.5 V	8.6	4.5		

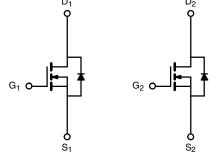
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_q and UIS Tested
- Compliant to RoHS Directive 2002/95/EC



APPLICATIONS

- CCFL Inverter
- DC/DC Converter
- HDD



N-Channel MOSFET

N-Channel MOSFET

		SO-8		
S ₁	1		8	D ₁
G_1	2		7	D_1
S_2	3		6	D_2
G_2	4		5	D_2
	ı	Top View		

Ordering Information: Si4288DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS (TA :	= 25 °C, unless other	erwise noted)			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V_{DS}	40	V		
Gate-Source Voltage		V_{GS}	± 20] '	
	T _C = 25 °C		9.2		
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 70 °C	I _D	7.4		
Continuous Brain Gunent (1) = 130 G)	T _A = 25 °C	טי	7.4 ^{b, c}		
	T _A = 70 °C		5.9 ^{b, c}	•	
Pulsed Drain Current (10 μs Pulse Width)		I _{DM}	50	Α	
Source-Drain Current Diode Current	$T_C = 25 ^{\circ}C$	I _S	2.6	^	
Source-Drain Current blode Current $T_A = 25$		'5	1.6 ^{b, c}		
Pulsed Source-Drain Current	I _{SM}	50			
Single Pulse Avalanche Current Single Pulse Avalanche Energy L = 0.1 mH		I _{AS}	10		
		E _{AS}	5		
	T _C = 25 °C		3.1		
Maximum Power Dissipation	T _C = 70 °C	P_D	2	W	
Maximum i ower bissipation	T _A = 25 °C	י ט	2 ^{b, c}	VV	
	T _A = 70 °C		1.28 ^{b, c}		
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Тур.	Max.	Unit		
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	49	62.5	°C/W		
Maximum Junction-to-Foot (Drain)	Steady-State	R_{thJF}	30	40] 5/**		

Notes:

- a. Based on T_C = 25 °C.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under steady state conditions is 120 $^{\circ}\text{C/W}.$

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SPECIFICATIONS (T _J = 25 °C	I		M:	т а	Marr	11	
Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit	
Static Static Malacan Malacan Malacan	V	V 0VI 050 ·· A	40				
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	40	40		V	
V _{DS} Temperature Coefficient	ΔV _{DS} /T _J	I _D = 250 μA		49		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	V V 1 050 A		- 5.2			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.2		2.5	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 40 V, V _{GS} = 0 V		1		μΑ	
<u> </u>	500	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$			10	μΛ	
On-State Drain Current ^b	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	20			Α	
Drain-Source On-State Resistance ^b	R _{DS(on)}	$V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$		0.0165	0.0200	Ω	
Diam-Source On-State Hesistance	1 103(011)	$V_{GS} = 4.5 \text{ V}, I_D = 7 \text{ A}$		0.019	0.023		
Forward Transconductance ^b	g _{fs}	$V_{DS} = 15 \text{ V}, I_{D} = 10 \text{ A}$		35		S	
Dynamic ^a							
Input Capacitance	C _{iss}			580		pF	
Output Capacitance	C _{oss}	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, I_D = 1 \text{ MHz}$		100			
Reverse Transfer Capacitance	C _{rss}			42			
Tatal Cata Chausa	Qg	V _{DS} = 20 V, V _{GS} = 10 V, I _D = 10 A		10	15	nC	
Total Gate Charge				4.9	7.4		
Gate-Source Charge	Q_{gs}	$V_{DS} = 20 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$		1.5			
Gate-Drain Charge	Q_{gd}]		1.5			
Gate Resistance	R_{g}	f = 1 MHz	0.6	2.7	5.4	Ω	
Turn-On Delay Time	t _{d(on)}			7	14		
Rise Time	t _r	$V_{DD} = 20 \text{ V}, R_{L} = 2 \Omega$		9	18	-	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		16	32		
Fall Time	t _f	1		8	16		
Turn-On Delay Time	t _{d(on)}			12	24	ns	
Rise Time	t _r	$V_{DD} = 20 \text{ V}, R_{L} = 2 \Omega$		10	20	1	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		13	26		
Fall Time	t _f	·		8	16		
Drain-Source Body Diode Characteristi	ics				l		
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			2.6	_	
Pulse Diode Forward Current ^a	I _{SM}				50	Α	
Body Diode Voltage	V _{SD}	I _S = 3 A		0.77	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}	-		15	30	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			7.5	15	nC	
Reverse Recovery Fall Time	t _a	$I_F = 5$ A, dl/dt = 100 A/μs, $T_J = 25$ °C		9			
Reverse Recovery Rise Time	t _b	<u> </u>		6		ns	

Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

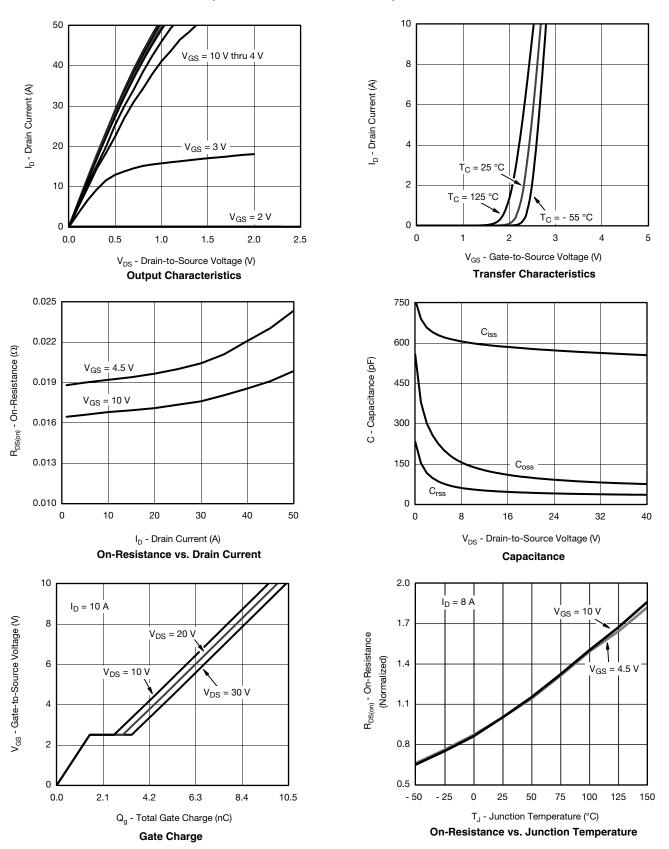
a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$



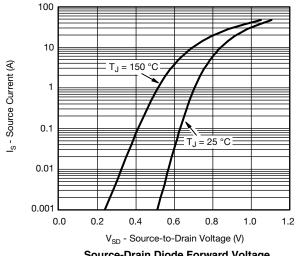


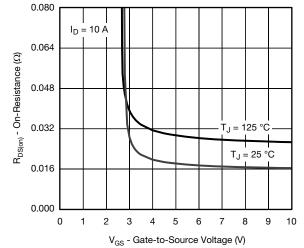
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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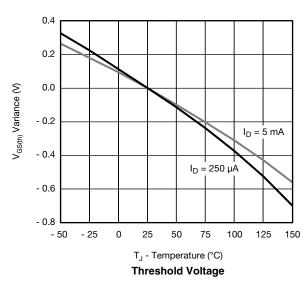
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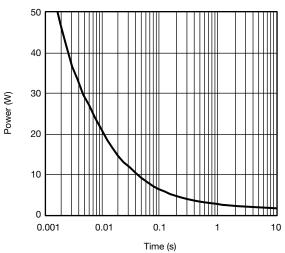




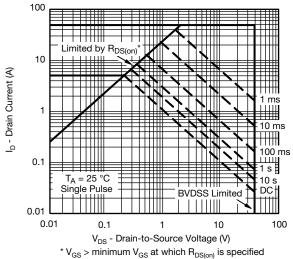
Source-Drain Diode Forward Voltage







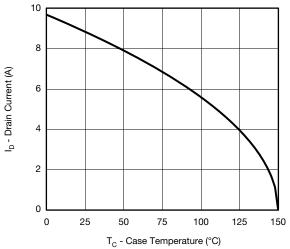
Single Pulse Power, Junction-to-Ambient



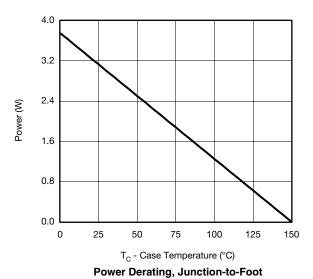
Safe Operating Area

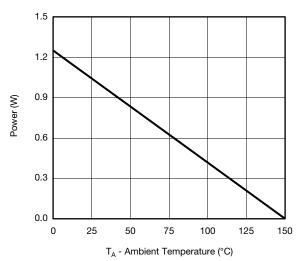


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating*





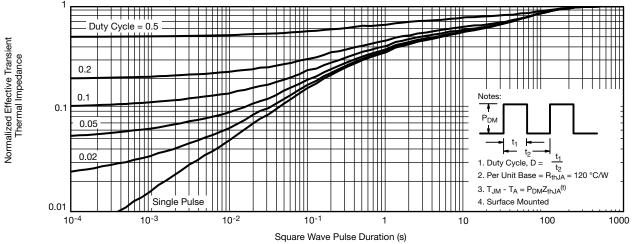
Power Derating, Junction-to-Ambient

^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

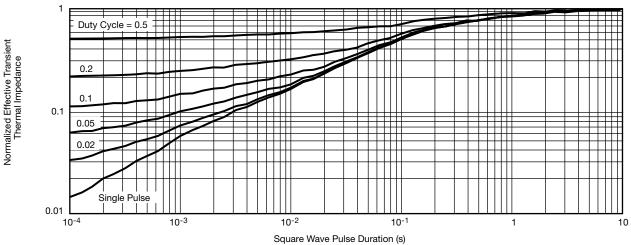
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

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RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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